

a current control TFT provided over said first substrate;

a current supply line provided over said first substrate and connected with said luminous element via said current control TFT;

a second substrate; and

a wiring for aiding said current supply line, said wiring for aiding said current supply line provided over said second substrate and electrically connected in parallel to said current supply line; and

a conductor for electrically connecting said current supply line and said wiring for aiding said current supply line.

2. (Original) A device according to claim 1, wherein said luminous element is an EL element.

3. (Currently Amended) A device according to claim 1, wherein said wiring for aiding said current supply line is second group of wirings are made of a metallic film selected from the group consisting of copper, silver, gold, aluminum and nickel, or an alloy film containing as a main component a material selected from the group consisting of copper, silver, gold, aluminum, and nickel.

4. (Previously Presented) A device according to claim 1, wherein said wiring for aiding said current supply line is formed into a layered structure made of a metallic film that is made of two or more different elements selected from copper, silver, gold, aluminum and nickel.

5. (Previously Presented) A device according to claim 1, wherein said wiring for aiding said current supply line is formed on a front surface of said second substrate, on a back surface thereof, or in the interior thereof.

6. (Previously Presented) A device according to claim 1, wherein a via hole that is covered by said wiring for aiding said current supply line is formed in said second substrate.

7. (Previously Presented) A light-emitting device, comprising:

- a first substrate;
- a luminous element provided over said first substrate;
- a current control TFT provided over said first substrate;
- a gate control wiring provided over said first substrate for transmitting a power source signal of a gate driver circuit, a clock signal or a start signal;
- a second substrate;
- a gate control auxiliary line provided over said second substrate and electrically connected in parallel to said gate control wiring;
- a conductor for electrically connecting said gate control wiring and said gate control auxiliary line; and
- a sealing agent for bonding said first substrate and said second substrate together.

8. (Original) A device according to claim 7, wherein said luminous element is an EL element.

9. (Previously Presented) A device according to claim 7, wherein said gate control auxiliary line is made of a metallic film containing a material selected from the group consisting of copper, silver, gold, aluminum and nickel, or an alloy film containing as a main component a material selected from the group consisting of copper, silver, gold, aluminum, and nickel.

10. (Previously Presented) A device according to claim 7, wherein said gate control auxiliary line is formed into a layered structure made of a metallic film that is made of two or more different elements selected from copper, silver, gold, aluminum and nickel.

11. (Previously Presented) A device according to claim 7, wherein said gate control auxiliary line is formed on a front surface of said second substrate, on a back surface thereof, or in the interior thereof.

12. (Currently Amended) A device according to claim 7, wherein a via hole that is covered by said gate control auxiliary line ~~second group of wirings~~ is formed in said second substrate.

13. (Currently Amended) A light-emitting device, comprising:

- a first substrate;
- a luminous element provided over said first substrate;
- a current control TFT provided over said first substrate;
- a current supply line provided over said first substrate and connected with said luminous element via said current control TFT;

a second substrate;

a wiring for aiding said current supply line, said wiring for aiding said current supply line provided over said second substrate and electrically connected in parallel to said current supply line;

a conductor for electrically connecting said current supply line and said wiring for aiding said current supply line;

a sealing agent for bonding said first substrate and said second substrate together; and

a resin filled in a space between said first substrate and said second substrate.

14. (Original) A device according to claim 13, wherein said luminous element is an EL element.

15. (Previously Presented) A device according to claim 13, wherein said wiring for aiding said current supply line is made of a metallic film containing a material selected from the group consisting of copper, silver, gold, aluminum and nickel, or an alloy film containing as a main component a material selected from the group consisting of copper, silver, gold, aluminum, and nickel.

16. (Previously Presented) A device according to claim 13, wherein said wiring for aiding said current supply line is formed into a layered structure made of a metallic film that is made of two or more different elements selected from copper, silver, gold, aluminum and nickel.

17. (Previously Presented) A device according to claim 13, wherein said wiring for aiding said current supply line is formed on a front surface of said second substrate, on a back surface thereof, or in the interior thereof.

18. (Previously Presented) A device according to claim 13, wherein a via hole that is covered by said wiring for aiding said current supply line is formed in said second substrate.